



TSW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Bandyopadhyay et al.

Attorney Docket No.:
NOVLP088/NVLS-002882

Application No.: 10/825,888

Examiner: Not yet assigned

Filed: April 16, 2004

Group: 2812

Title: METHOD TO IMPROVE MECHANICAL
STRENGTH OF LOW-K DIELECTRIC FILM
USING MODULATED UV EXPOSURE

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on November 16, 2005 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed:

Tara Hayden
Tara Hayden

REQUEST FOR STATUS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant hereby requests status of the above-referenced patent application. This application was filed on April 16, 2004 and no response has been received as of this date.

Respectfully submitted,

BEYER WEAVER & THOMAS, LLP

Denise Bergin

Denise S. Bergin
Registration No. 50,581

P.O. Box 70250
Oakland, CA 94612-0250